

SKKT 132 H4, SKKH 132 H4



SEMIPACK® 2

Thyristor / Diode Modules

SKKH 132 H4

SKKT 132 H4

Features

- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- Hard soldered joints for high reliability
- UL recognized, file no. E 63 532

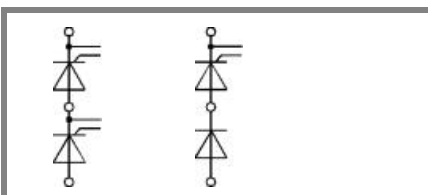
Typical Applications

- DC motor control (e. g. for machine tools)
- Temperature control (e. g. for ovens, chemical processes)
- Professional light dimming (studios, theaters)

1) See the assembly instructions

| | | | |
|----------------|-------------------------|--|-----------------|
| V_{RSM} V | V_{RRM}, V_{DRM} V | $I_{TRMS} = 220$ A (maximum value for continuous operation) $I_{TAV} = 132$ A (sin. 180; $T_c = 84$ °C) | |
| 2100 | 2000 | SKKT 132/20E H4 | SKKH 132/20E H4 |
| 2300 | 2200 | SKKT 132/22E H4 | SKKH 132/22E H4 |

| Symbol | Conditions | Values | Units |
|------------------|---|----------------------------|--------------------------------------|
| I_{TAV} | sin. 180; $T_c = 85$ (100) °C; | 128 (90) | A |
| I_{TSM} | $T_{vj} = 25$ °C; 10 ms $T_{vj} = 125$ °C; 10 ms | 4500 3800 | A A |
| i^2t | $T_{vj} = 25$ °C; 8,3 ... 10 ms $T_{vj} = 125$ °C; 8,3 ... 10 ms | 100000 72000 | A ² s A ² s |
| V_T | $T_{vj} = 25$ °C; $I_T = 500$ A | max. 1,8 | V |
| $V_{T(TO)}$ | $T_{vj} = 125$ °C | max. 1,1 | V |
| r_T | $T_{vj} = 125$ °C | max. 2 | mΩ |
| $I_{DD}; I_{RD}$ | $T_{vj} = 125$ °C; $V_{RD} = V_{RRM}; V_{DD} = V_{DRM}$ | max. 40 | mA |
| t_{gd} | $T_{vj} = 25$ °C; $I_G = 1$ A; $di_G/dt = 1$ A/μs | 1 | μs |
| t_{gr} | $V_D = 0,67 * V_{DRM}$ | 2 | μs |
| $(di/dt)_{cr}$ | $T_{vj} = 125$ °C | max. 200 | A/μs |
| $(dv/dt)_{cr}$ | $T_{vj} = 125$ °C | max. 1000 | V/μs |
| t_q | $T_{vj} = 125$ °C | 50 ... 150 | μs |
| I_H | $T_{vj} = 25$ °C; typ. / max. | 150 / 400 | mA |
| I_L | $T_{vj} = 25$ °C; $R_G = 33$ Ω; typ. / max. | 300 / 1000 | mA |
| V_{GT} | $T_{vj} = 25$ °C; d.c. | min. 2 | V |
| I_{GT} | $T_{vj} = 25$ °C; d.c. | min. 150 | mA |
| V_{GD} | $T_{vj} = 125$ °C; d.c. | max. 0,25 | V |
| I_{GD} | $T_{vj} = 125$ °C; d.c. | max. 10 | mA |
| $R_{th(j-c)}$ | cont.; per thyristor / per module | 0,17 / 0,085 | K/W |
| $R_{th(j-c)}$ | sin. 180; per thyristor / per module | 0,18 / 0,09 | K/W |
| $R_{th(j-c)}$ | rec. 120; per thyristor / per module | 0,2 / 0,1 | K/W |
| $R_{th(c-s)}$ | per thyristor / per module | 0,1 / 0,05 | K/W |
| T_{vj} | | - 40 ... + 125 | °C |
| T_{stg} | | - 40 ... + 125 | °C |
| V_{isol} | a. c. 50 Hz; r.m.s.; 1 s / 1 min. | 4800 / 4000 | V~ |
| M_s | to terminal | 5 ± 15 % ¹⁾ | Nm |
| M_t | to terminal | 5 ± 15 % | Nm |
| a | | $5 * 9,81$ | m/s ² |
| m | approx. | 175 | g |
| Case | SKKT SKKH | A 21 A 22 | |



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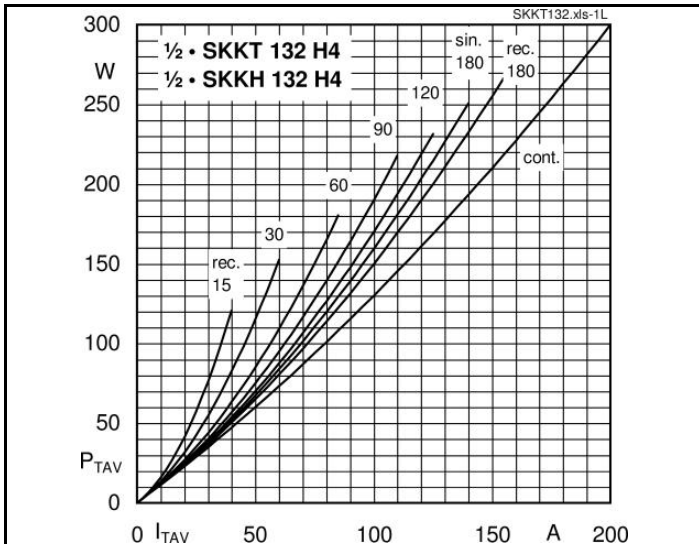


Fig. 1L Power dissipation per thyristor vs. on-state current

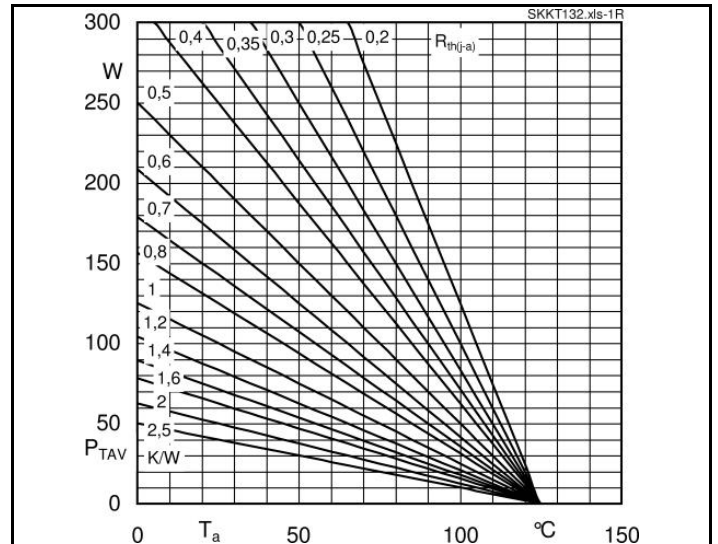


Fig. 1R Power dissipation per thyristor vs. ambient temp.

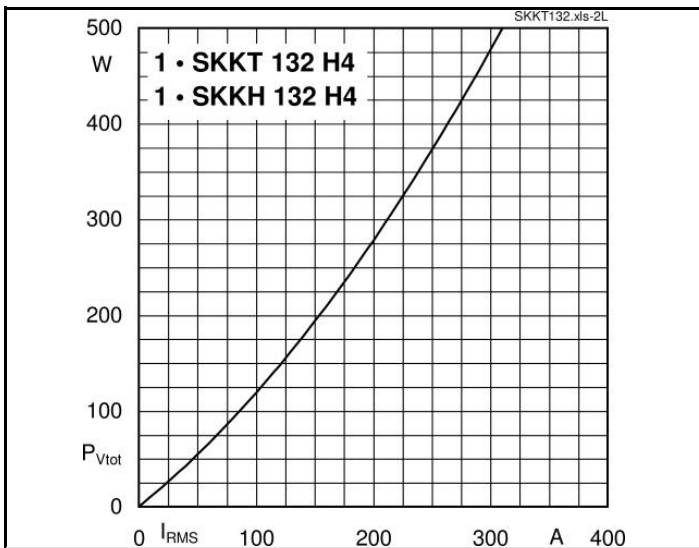


Fig. 2L Power dissipation per module vs. rms current

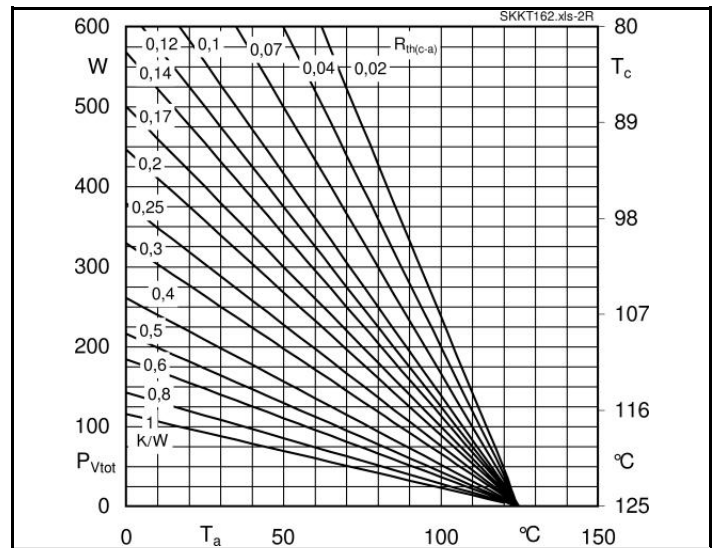


Fig. 2R Power dissipation per module vs. case temp.

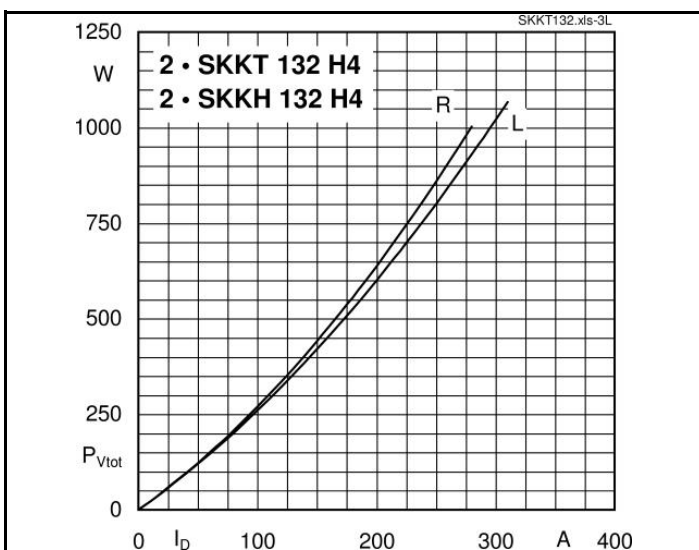


Fig. 3L Power dissipation of two modules vs. direct current

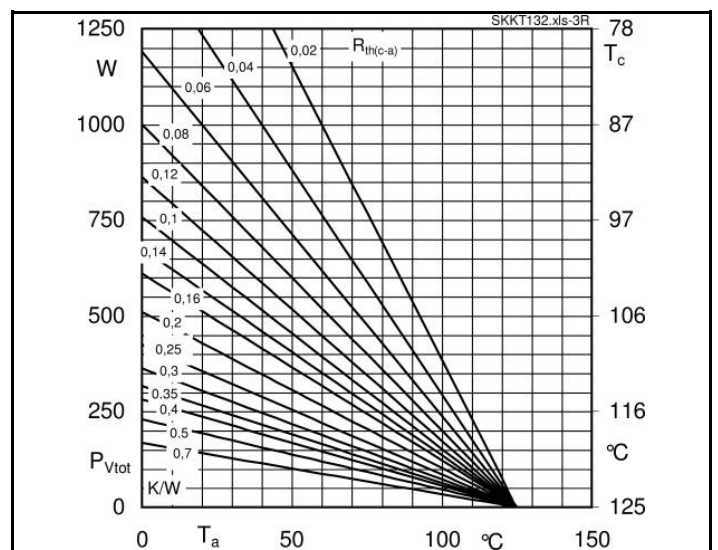
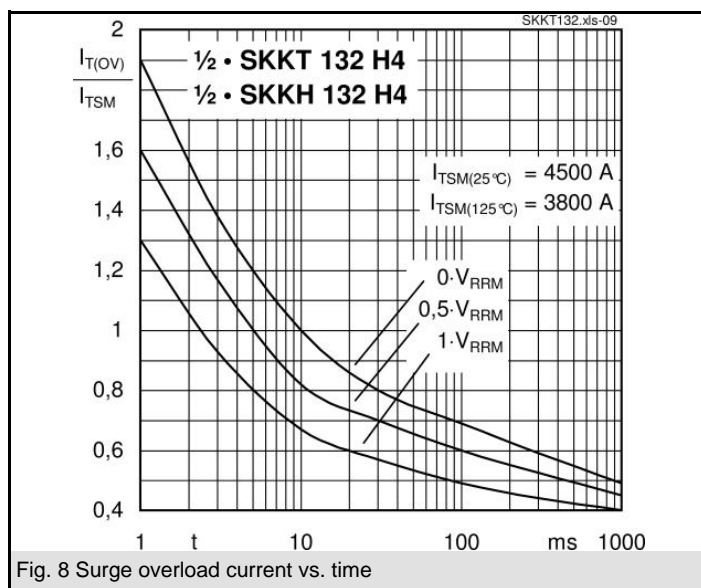
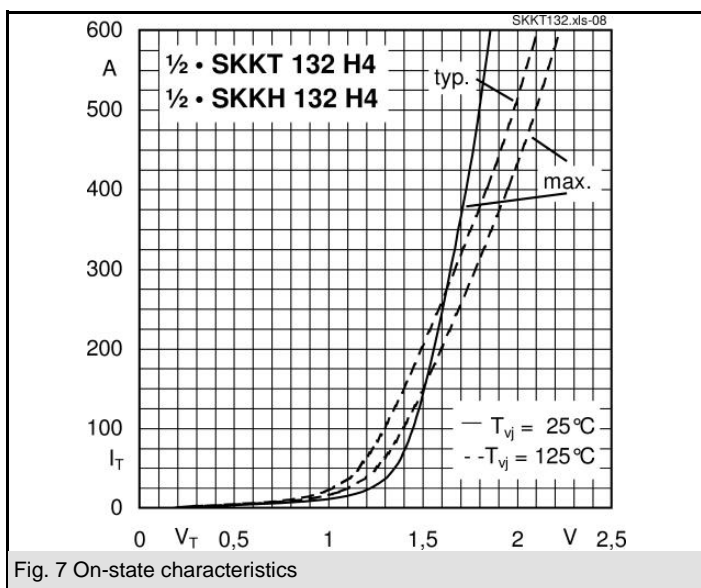
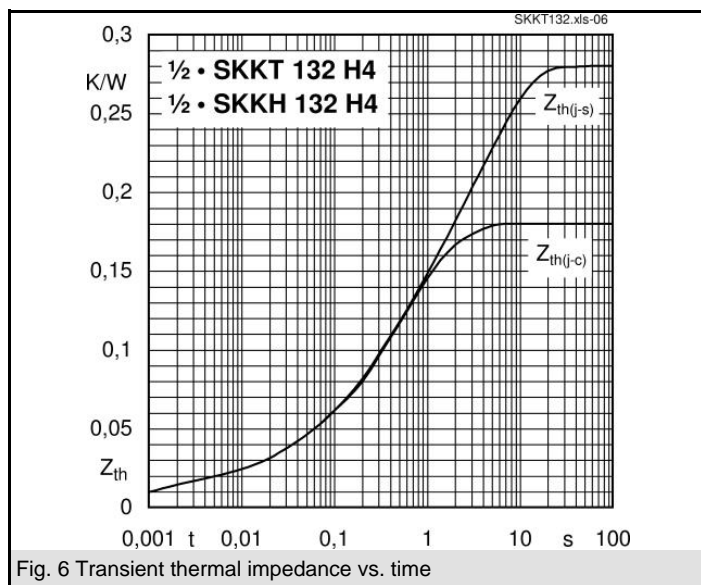
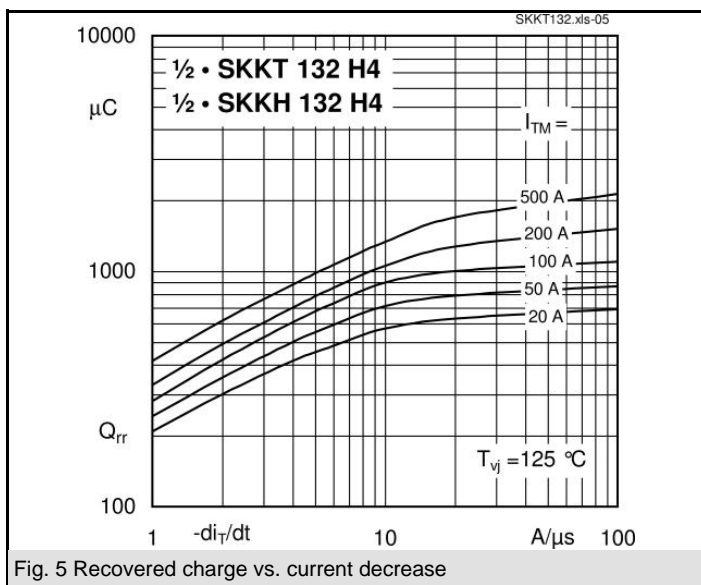
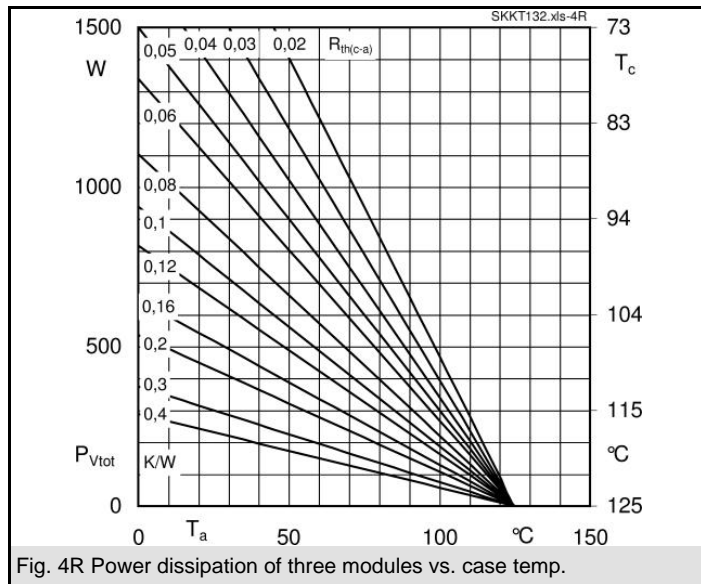
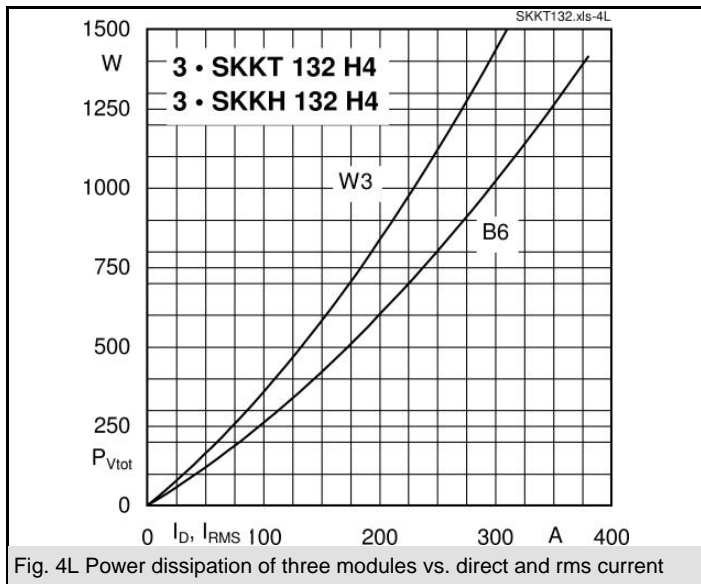
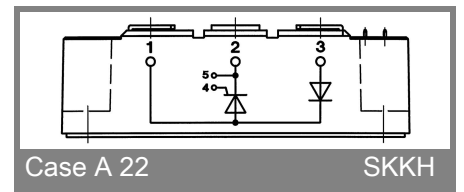
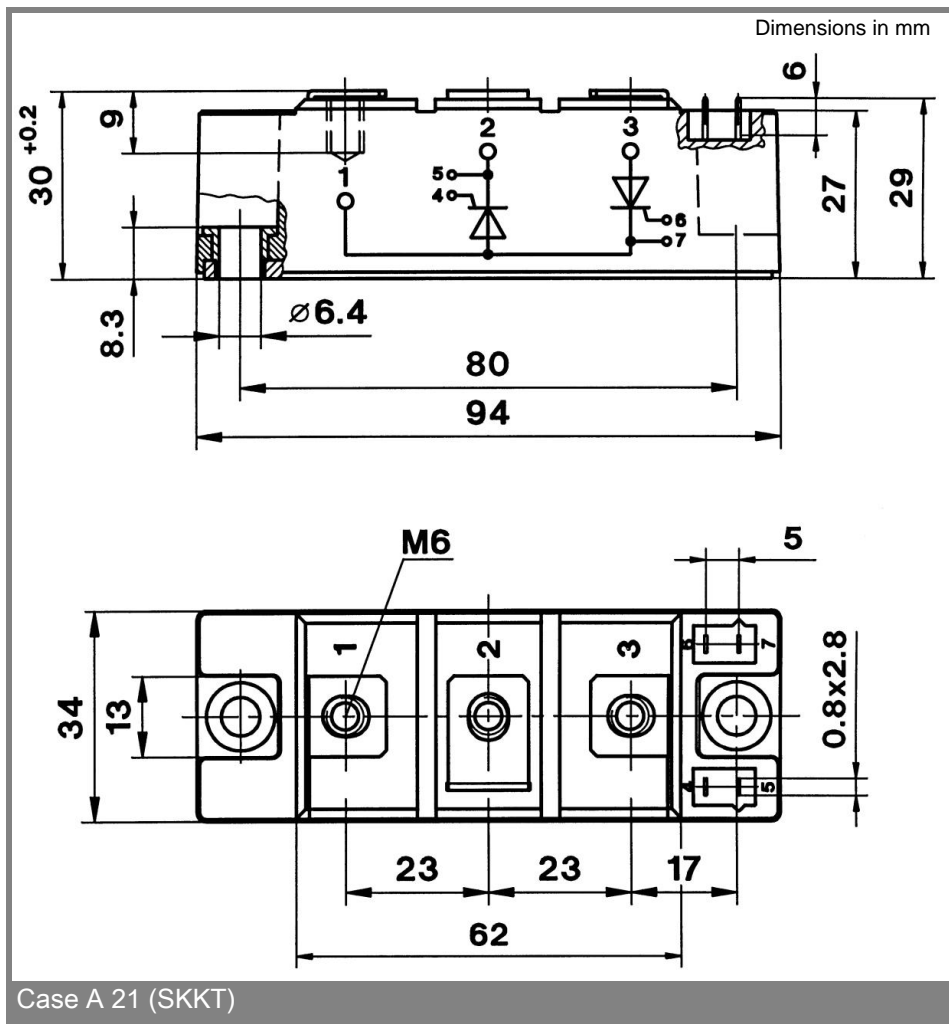
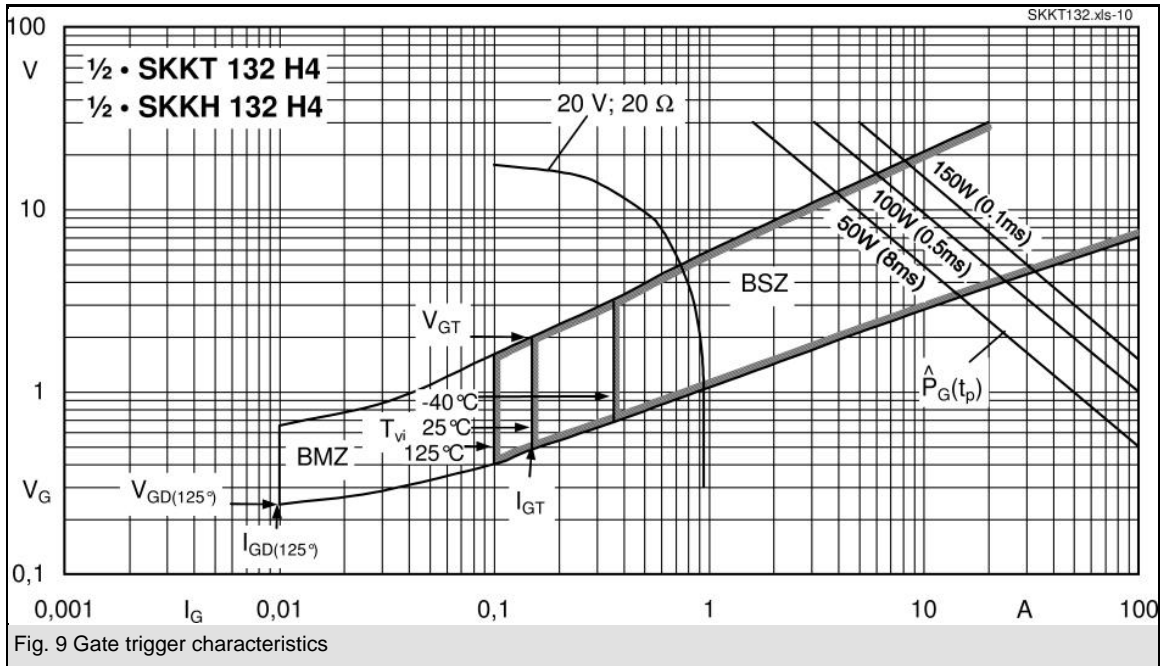


Fig. 3R Power dissipation of two modules vs. case temp.

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